

ABSTRACT OF THE DISCLOSURE

A digital image capturing module assembly and method of fabricating the same is proposed, which is used for the assembly of a digital image capturing module from a photosensitive printed circuit board and a lens holder. The proposed assembly method is characterized by the provision of a ring plane between focusing plane and corner-located aligning posts on the lens holder so as to allow the coated adhesive layer over the ring plane to provide a sealed light impenetrable effect at the junction between the photosensitive printed circuit board and the lens holder. This feature allows the captured image by the digital image capturing module to be substantially free of sidelight effect and thus more assured in picture quality. Moreover, it can simplify the assembly process to help increase the yield of the fabrication of digital image capturing modules.

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